



SDI Review Form 1.6

Journal Name:	British Journal of Mathematics & Computer Science
Manuscript Number:	2014_BJMCS_15619
Title of the Manuscript:	Social Learning under Uncertainty Based on Dempster-Shafer Approach for Minimizing True Error of Machine Learning
Type of the Article	

General guideline for Peer Review process:

This journal's peer review policy states that **NO** manuscript should be rejected only on the basis of '**lack of Novelty**', provided the manuscript is scientifically robust and technically sound.

To know the complete guideline for Peer Review process, reviewers are requested to visit this link:

(<http://www.sciencedomain.org/page.php?id=sdi-general-editorial-policy#Peer-Review-Guideline>)



SDI Review Form 1.6

PART 1: Review Comments

	Reviewer's comment	Author's comment (if agreed with reviewer, correct the manuscript and highlight that part in the manuscript. It is mandatory that authors should write his/her feedback here)
<u>Compulsory</u> REVISION comments	1. In the textbox "The first stage: TCML..." in section 3, "I" in line 5 and 8 should be "i", and "b" in line 9 should be "B". 2. In the textbox "The second stage of ..." in section 3, "matrix b=" in line 8 should be "matrix B=", and "Z" in the following equation should be "C".	
<u>Minor</u> REVISION comments	1. "basic belief assignment (BBA)" in line 6, section 2 which has been mentioned in line 4, the same paragraph, so just BBA is enough here. 2. There should be a blank between "at" and "http://..." in the third line of 4.2 3. Please unify all the number of decimal digits for the value in Tables 2, 4, 5.	
<u>Optional/General</u> comments	The benchmarks used in the experiments are widely used in a number of other studies. Why only choose six datasets for the experiments. More datasets will be better.	

Reviewer Details:

Name:	Ting Wang
Department, University & Country	State Key Laboratory of Intelligent Technology and Systems, Tsinghua National Laboratory for Information Science and Technology, Department of Computer Science and Technology, Tsinghua University, Beijing 100084, China